

Product / Process Change Notice

No.: Z200-PCN-TM202302-01-A Date: February 22, 2023 Change Title: To add an additional chip probing (CP) testing site Walton for 64Mb with 58nm Flash automotive products. Change Classification: ✓ Major ✓ Minor with customer notification ✓ Minor without customer notification Change item : □ DataSheet □ Design □ Raw Material □ Wafer FAB □ Assembly ☑ Testing □ Packing □ Others Affected Product(s): Please refer to Table 1 in details. Description of Change(s) To add new CP site Walton Advanced Engineering, Inc. (Address: No. 18, North First Road, K.E.P.Z. 806 Kaohsiung, Taiwan, R.O.C) Reason for Change(s): To increase the CP capacity and meet customers delivery requirement. Impact of Change(s): (positive & negative) Form: No Change Fit: No Change Function: No Concern (Please refer to attachment I & II) Reliability: No Concern (Please refer to attachment I & II) Hazardous Substances: No Change Qualification Plan/ Results : (1) Walton is one company with IATF 16949, ISO 14001 and OHSAS18001 certification. (Please refer to attachment III) (2) Base on Winbond CP/FT stage Correlation spec., the Walton meets our criteria. (Please refer to attachment I & II) Implementation Plan: ☑ Date Code: 2320 onward ☐ Lot No: onward ■ Proposed first ship date: Approval: (QA Approval: Originator: Hyhuang (QA) Dept. Manager) (QRA Director) Name: Betty Huang TEL:886-3-5678168 (ext.76549) FAX: 886-3-5796124 Address: No. 8.Keva 1st Rd., Dava Dist., Central Taiwan Science Park, Taichung Contact for Questions City 42881, Taiwan & Concerns

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Customer Comments:

Note: Please sign this notice, and return to Winbond contact within **30** days. If no response is received within **30** days, this Change Request will be assumed to meet your approval.

Major change: □ Approval	■ Disapproval	□ Conditional Approval :				
Minor change with customer notification: □ Recognition						
Minor change without customer notification: □ Approval □ Disapproval						
□ Conditional Approval :		<u></u>				
Comment:						
Date:						
Dept. name:						
Person in charge:		<u>_</u>				

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Table 1. The affected part no are list below.

W25Q64JVXGAQ	W25Q64JVTBSM	W25Q64JVXGBQ	W25Q64JVSFBM	W25Q64JVZPBQ
W25Q64JVSSSQ	W25Q64JVTBAM	W25Q64JVXGSM	W25Q64JVSFAQ	W25Q64JVZPBM
W25Q64JVSSBQ	W25Q64JVTBBM	W25Q64JVXGAM	W25Q64JVSFBQ	W25Q64JVZESM
W25Q64JVSSAQ	W25Q64JVXGSQ	W25Q64JVXGBM	W25Q64JVSFSM	W25Q64JVZEBM
W25Q64JVSFSQ	W25Q64JVSSSM	W25Q64JVZPSM	W25Q64JVSFAM	W25Q64JVZESQ
W25Q64JVTBSQ	W25Q64JVSSAM	W25Q64JVZPAM	W25Q64JVZPSQ	W25Q64JVZEAQ
W25Q64JVTBAQ	W25Q64JVSSBM	W25Q64JVZEAM	W25Q64JVZPAQ	W25Q64JVZEBQ
W25Q64JVTBBQ				

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